

se record the attached original documents or copy thereof Name and address of receiving party(ies) Name: Hynix Semiconductor Inc. Internal Address: Street Address: San 136-1, Ami-Ri, Bubal-Eub, Ichon-Shi City: Kyoungki-Do State: Republic of Korea Zip: 467-860 Additional name(s) & Yes x No address(es) attached: tion date of the new application is: 12/10/02 Patent No.(s):
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Yes x No
Total number of applications and patents involved:
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Authorized to be charged to deposit account
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December 12, 2002
December 12, 2002 Signature Date
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ERROR! UNKNOWN DOCUMENT PROPERTY NAME.

Atty. Docket No: 29926/38988

ASSIGNMENT

Serial No:	
Filed:	
Title: SEMICONDUCTOR MEMORY DEVICE EMPLOYING TEM	PERATURE DETECTION CURCUIT
For good and valuable consideration, the receipt and sufficiency wh	hereof are hereby acknowledged, the undersigned
hereby assign(s) to Hynix Semiconductor Inc.	······································
(hereinafter "Assignee"), its successors and assigns, the entire right, title and	d interest in the invention or improvements of the
undersigned disclosed in an application for Letters Patent of the Un December 10, 2002 , and in said application and any a	nited States, executed by the undersigned on and all other applications, which the undersigned
may file, either solely or jointly with others, on said invention or improve	ements, and in any and all Letters Patent of the
United States, which may be obtained on any of said applications, and in any	y reissue or extension thereof.
The undersigned hereby authorize(s) and request(s) the Commis	ssioner of Patents and Trademarks to issue said
Letters Patent to said assignee.	
The undersigned hereby authorize(s) and request(s) the attorney	s of record in said application to insert in this
assignment the execution date and/or filing date and serial number of said ap	pplication when officially known.
The undersigned warrant(s) themselves (himself/herself) to be the	e owners (owner) of the interest herein assigned
and to have the right to make this assignment and further warrant(s) that the	ere are no outstanding prior assignments, licenses,
or other rights in the interest herein assigned.	
For said consideration the undersigned hereby agree(s), upon the	request and at the expense of said assignee, its
successors and assigns, to execute any and all divisional, continuation, co	ntinuation-in-part and substitute applications for
said invention or improvements, and any necessary oath or affidavit relating	ng thereto, and any application for the reissue or
extension of any Letters Patent that may be granted upon said application,	that said assignee, its successors or assigns, may
deem necessary or expedient, and for the aforesaid consideration the unde	ersigned further agree(s) upon the request of said
assignee, its successors or assigns, in the event of any application or Lette	ers Patent assigned herein becoming involved in
Interference, to cooperate to the best of the ability of the undersigned with	th said assignee, its successors or assigns, in the
matters of preparing and executing the preliminary statement and giving	and producing evidence in support thereof, the
undersigned hereby agreeing to perform, upon request, any and all affirmat	tive acts to obtain said Letters Patent, and vest all
rights therein hereby conveyed in said assignee, its successors and assign	ns, whereby said Letters Patent will be held and
enjoyed by said assignee, its successors and assigns, to the full end of the to	erm for which said Letters Patent may be granted
as fully and entirely as the same would have been held and enjoyed by the	e undersigned if this assignment and sale had not
been made.	
WITNESS my (our) hand(s) this day of	, 2002.
Witnesses:	Jung In chil
1) 100-: Mym & He 0	JUNG, IN CHUL
1) LL, Myn JH-LL Name: LEE, MYUNG-HEE	S S. Yang
	S S Yang YANG, SUK-SEON
2)	
Name: LIM, HYE-YOUNG	

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RECORDED: 12/12/2002

REEL: 013585 FRAME: 0567